# HFMP1335 TYPE

## **FEATURE**

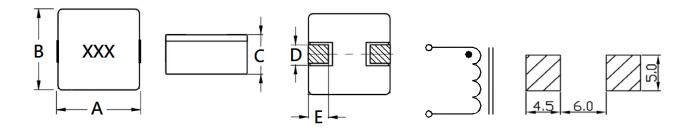
- 1. Shielded construction
- 2. High current and low DCR for flat wire type
- 3. Cross out as Wurth 744313xxx

### Applications

1. Notebook, server application, High current power supplier

## Shape and Dimension

Schematics and Land Patterns(mm)



 $A = 13.00 \pm 1.00 \text{m/m} \; ; \; B = 12.80 \pm 0.50 \text{m/m} \; ; \; C = 3.50 \text{m/m} \; \text{MAX}; \; D = 2.50 \pm 0.50 \text{m/m}; \; E = 3.00 \pm 1.00 \text{m/m}; \; E = 3.$ 

## Specification

|               | L        | RDC          | RDC      | Isat | Irms |
|---------------|----------|--------------|----------|------|------|
| P/N           | (µH)     | (mΩ) Typical | (mΩ) Max | (A)  | (A)  |
| HFMP1335-R25N | 0.25±30% | 0.75         | 0.83     | 60   | 24   |
| HFMP1335-R68M | 0.68±20% | 1.58         | 1.74     | 40   | 22   |
| HFMP1335-1R2M | 1.2±20%  | 2.85         | 3.14     | 28   | 17   |
| HFMP1335-1R8M | 1.8±20%  | 5.60         | 6.16     | 22   | 14   |
| HFMP1335-2R2M | 2.2±20%  | 5.70         | 6.27     | 18   | 14   |
| HFMP1335-3R3M | 3.3±20%  | 8.10         | 8.91     | 14   | 12   |

Note1. Measurement frequency of Inductance value: at 100KHz

Note2. Measurement ambient temperature of L, DCR and IDC: at 25°C

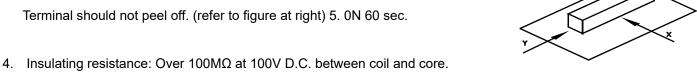
Note3. Isat: DC current at which the inductance drops 30%(typ) from its value without current

Note4. Irms: Average current for 50°C temperature rise from 25°C ambient(typical)

Note5. Inductance tolerance: M: ±20%, N: ±30% Note6. Packaging: Taping; Quantity: 500 pieces/reel

# GENERAL CHARACTERISTICS

- 1. Operating temperature range: -40 TO + 150°C (Includes temperature when the coil is heated)
- 2. External appearance: On visual inspection, the coil has no external defects.
- Terminal strength: After soldering. Between copper plate and terminals of coil. Push in two directions of X.Ywithstanding at below conditions.



- Dielectric strength: No dielectric breakdown at 100V D.C. for 1 minute between coil and core.
- Temperature characteristics: Inductance coefficient (0~2,000)x10-6/°C (-25~+80°C).
- Humidity characteristics(Moisture Resistance): Inductance deviation within ±5%, after 96 hours in 90~95% relative humidity at 40 ±2°C and 1 hour drying under normal condition.
- 8. Vibration resistance: Inductance deviation within ±5%, after vibration for 1 hour. In each of three orientations at sweep vibration (10~55~10 Hz) with 1.5mm P-P amplitudes.
- 9. Shock resistance: Inductance deviation within ±5%, after being dropped once with 981m/s2 (100G) shock attitude upon a rubber block method shock testing machine, in three different orientations.
- 10. Resistance to Soldering Heat: 260℃, 10 seconds(See attached recommend reflow)
- 11. Storage environment: Storage condition: Temperature Range:  $10^{\circ}$ C ~  $35^{\circ}$ C (Generally:  $21^{\circ}$ C ~  $31^{\circ}$ C) , Humidity Range: 50% ~ 80% RH (Generally: 65% ~ 75%); Transportation condition: Temperature Range: -35°C ~ 85°C , Humidity Range: 50% ~ 95% RH
- 12. Use components within 12 months. If 12 months or more have elapsed, check solderability before use.
- 13. Reflow profile recommend:

#### Lead-free heat endurance test

#### Lead-free the recommended reflow condition

